

# **Product Change Notification**

*PCN #: 5C-2018* 

DATE: 10<sup>th</sup> May 2018

# **1 PRODUCTS AFFECTED**

Laird Part Number	Description	
BL652-SA-01	Bluetooth v5 Module + NFC (Integrated Antenna)	
BL652-SC-01	Bluetooth v5 Module + NFC (External Antenna)	
BL652-SA-01-T/R	Bluetooth v5 Module + NFC (Integrated Antenna) – Tape & Reel	
BL652-SC-01-T/R	Bluetooth v5 Module + NFC (External Antenna) – Tape & Reel	
DVK-BL652-SA-01	Development Kit - Bluetooth v5 Module + NFC (Integrated Antenna)	
DVK-BL652-SC-01	Development Kit - Bluetooth v5 Module + NFC (External Antenna)	

## **2 DESCRIPTION OF CHANGES**

The BL652 Series of modules and associated development kits utilise the Nordic Semiconductor nRF52832-QFAA silicon. Starting from the **Build Code 1820** listed on each module's individual product label, Laird will be utilising the new E00 revision of the Nordic nRF52832-QFAA silicon inside the module.

There is no Form, Fit, Function, Quality or Reliability change in this PCN.

Laird

## **3** REASON FOR CHANGE

The BL652 Series of modules and associated development kits utilise the Nordic Semiconductor nRF52832-QFAA silicon. Nordic have recently announced via their 'Information Notice' programme (Notice no: IN-105, rev 1.0) that they are updating their Device version / Build Code from B00 to E00.

The Information Notice states the following:

Description of change:				
New revision of the IC with the following key changes.				
Fixes of anomalies The new IC revision includes fixes for the following anomalies reported in nRF52832 Rev 1 Errata v1.6.				
<ul> <li>#102 RADIO: PAYLOAD/END events delayed or not triggered after ADDRESS</li> <li>#106 RADIO: Higher CRC error rates for some access addresses</li> <li>#107 RADIO: Immediate address match for access addresses containing MSBs 0x00</li> </ul>				
nRF52832 Rev 2 will have its own Errata, nRF52832 Rev 2 Errata v1.0, which includes an updated list of anomalies.				
In order to be drop-in compatible with current B00 / B10 build codes, the fix introduced is opt-in.				
Impact: Does the change affect <u>product</u> :				
1. Form No Yes – describe:				
2. Fit 🛛 No 🗌 Yes – describe:				
3. Function 🛛 No 🗌 Yes – describe:				
<ol> <li>Quality or Reliability</li></ol>				
Classification of change 🛛 Minor 🗌 Major				
Reason for change:				
Fixed anomalies in affected devices.				
Consequences of change:				
Hardware				
The new device versions are drop-in compatible with the current versions.				
Software:				
The new device versions are software compatible with the current revision, but note the following:				
<ul> <li>For the fix of anomalies to take effect, re-compilation with MDK version 8.15.1 and later is necessary</li> <li>It is also possible to manually enable the fix as described in nRF52832 Rev 2 Errata v1.0x, #182</li> <li>Note that SoftDevice S132 versions 4.0.2 until version 5.x have workarounds for the #102, #106 and #107 anomalies implemented.</li> <li>SoftDevice S132 version 6.x will apply the fix (according to Errata #182) for Rev2.</li> </ul>				
<ul> <li>Note that SoftDevice S132 versions 4.0.2 until version 5.x have workarounds for the #102, #106 and #107 anomalies implemented.</li> </ul>				
<ul> <li>Note that SoftDevice S132 versions 4.0.2 until version 5.x have workarounds for the #102, #106 and #107 anomalies implemented.</li> </ul>				



## **4 ANTICIPATED IMPACT OF THE CHANGE**

None

# 5 METHOD OF IDENTIFYING THE CHANGED PRODUCT

The change can be identified by reviewing the **Build Code** number that is present on the individual module, reel label and carton label. The images below identify where this **Build Code** is located on each of those labels.

A Build Code that starts with **1820**, and all subsequent incremental numbers, indicates that the nRF5283-QFAA-E00 silicon is utilised.

Label examples shown are for the -SA versions, all -SC versions follow the same format.

#### 5.1 Module Label



Figure 1: Module label

#### 5.2 Reel Label



Figure 2: Reel label



### 5.3 Carton Label

Laird Technologies			
Model Name:BL652-SA-01-T/R			
Date code:1820			
Q`TY:5000PCS			
C/No: 1			
N.W.: 6.0Kgs			
G.W.: 6.6Kgs			
Made in China			

Figure 3: Master carton package label

# **6 FACTORY EFFECTIVITY DATE**

This change has been implemented as a running change into Laird manufacturing of the BL652 Series modules. Production builds utilizing the new silicon revision will start from May 15<sup>th</sup> 2016 for BL652-SA parts and June 10<sup>th</sup> for BL652-SC parts. It is envisaged it will take some months for these modules to proliferate out into the global distribution channels.

## **7 CONTACT INFORMATION:**

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